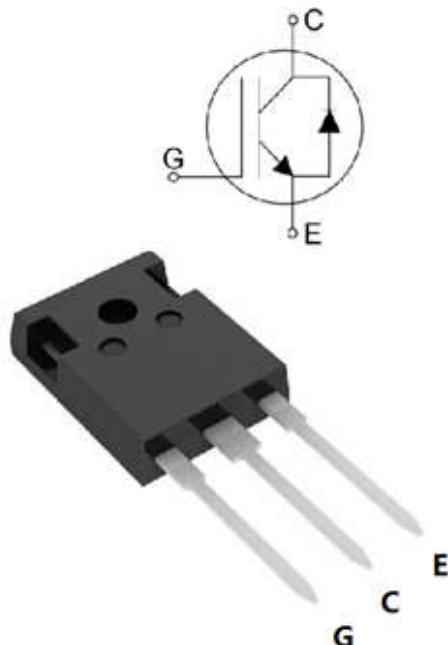


- High breakdown voltage to 1200V for improved reliability
- Trench-Stop Technology offering :
  - High speed switching
  - High ruggedness, temperature stable
  - Low  $V_{CE(sat)}$
  - Easy parallel switching capability due to positive temperature coefficient in  $V_{CE(sat)}$
- Enhanced avalanche capability

<b><math>V_{CE}</math></b>	<b>1200</b>	<b>V</b>
<b><math>I_C</math></b>	<b>25</b>	<b>A</b>
<b><math>V_{CE(sat)}</math> <math>I_C=25A</math></b>	<b>2.0</b>	<b>V</b>



## APPLICATION

- Uninterruptible Power Supplies
- Solar inverter
- Welding
- PFC applications

Product	Package	Packaging
YGW25N120F1A1	TO247	Tube

## Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	$V_{CE}$	1200	V
DC collector current, limited by $T_{jmax}$ $T_C = 25^\circ C$ $T_C = 100^\circ C$	$I_C$	50 25	A
Diode Forward current, limited by $T_{jmax}$ $T_C = 25^\circ C$ $T_C = 100^\circ C$	$I_F$	50 25	A
Continuous Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Transient Gate-emitter voltage	$V_{GE}$	$\pm 30$	V
Turn off safe operating area $V_{CE} \leq 1200V$ , $T_j \leq 150^\circ C$	-	75	A
Pulsed collector current, $V_{GE} = 15V$ , $t_p$ limited by $T_{jmax}$	$I_{CM}$	75	A
Power dissipation , $T_j=25^\circ C$	$P_{tot}$	260	W
Operating junction temperature	$T_j$	-40...+150	°C
Storage temperature	$T_s$	-55...+150	°C
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	°C

## Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_\theta(j-c)$	0.48	K/W
Diode thermal resistance, junction - case	$R_\theta(j-c)$	1.2	K/W
Thermal resistance, junction - ambient	$R_\theta(j-a)$	40	K/W

**Electrical Characteristics of the IGBT (T<sub>j</sub>= 25°C unless otherwise specified) :**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Collector-Emitter breakdown voltage	BV <sub>CES</sub>	V <sub>GE</sub> =0V, I <sub>C</sub> =1mA	1200	-	-	V
Gate threshold voltage	V <sub>GE(th)</sub>	V <sub>GE</sub> =V <sub>CE</sub> , I <sub>C</sub> =250μA	5.1	5.8	6.4	V
Collector-Emitter Saturation voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> =15V, I <sub>C</sub> =25A T <sub>j</sub> = 25°C T <sub>j</sub> = 150°C	- -	2.0 2.5	2.5 -	V
Zero gate voltage collector current	I <sub>CES</sub>	V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V T <sub>j</sub> = 25°C T <sub>j</sub> = 150°C	- -	<1 -	100 1000	μA
Gate-emitter leakage current	I <sub>GES</sub>	V <sub>CE</sub> = 0V, V <sub>GE</sub> = ± 20V	-	-	100	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic</b>						
Input capacitance	C <sub>ies</sub>	V <sub>CE</sub> = 25V, V <sub>GE</sub> = 0V, f = 1MHz	-	2500	-	pF
Output capacitance	C <sub>oes</sub>		-	70	-	
Reverse transfer capacitance	C <sub>res</sub>		-	50	-	
Gate charge	Q <sub>G</sub>	V <sub>CC</sub> = 640V, I <sub>C</sub> = 25A, V <sub>GE</sub> = 15V	-	135	-	nC

**Switching Characteristic, Inductive Load**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic , at <math>T_j = 25^\circ C</math></b>						
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 25A,$ $V_{GE} = 0/15V,$ $R_g=10\Omega$	-	35	-	ns
Rise time	$t_r$		-	32	-	ns
Turn-on energy	$E_{on}$		-	2.0	-	mJ
Turn-off delay time	$t_{d(off)}$		-	180	-	ns
Fall time	$t_f$		-	40	-	ns
Turn-off energy	$E_{off}$		-	0.32	-	mJ

**Electrical Characteristics of the DIODE ( $T_j = 25^\circ C$  unless otherwise specified)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic</b>						
Diode Forward Voltage	$V_{FM}$	$I_F = 25A$ , $I_{rr}= 25A,$ $di/dt= 600A/\mu s$	-	3.1	-	V
Reverse Recovery Time	$T_{rr}$		-	420	-	ns
Reverse Recovery Current	$I_{rr}$		-	17	-	A
Reverse Recovery Charge	$Q_{rr}$		-	2570	-	nC

Fig. 1 Output characteristics

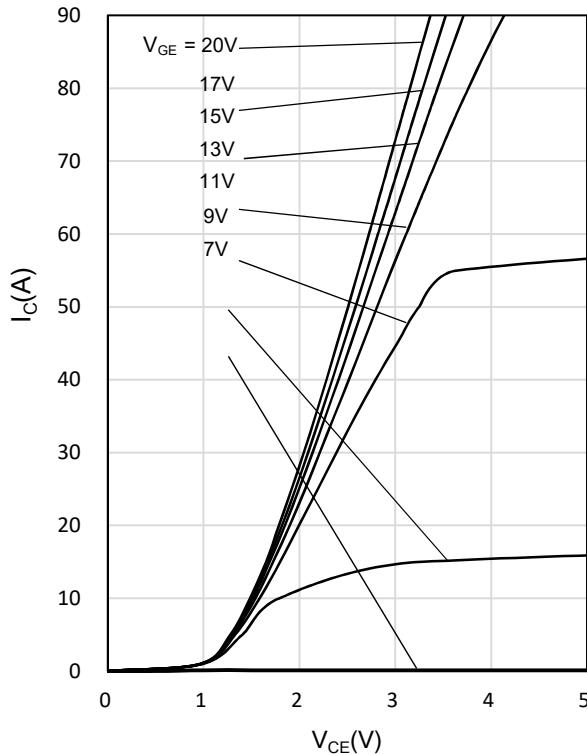


Fig. 2 Saturation voltage characteristics

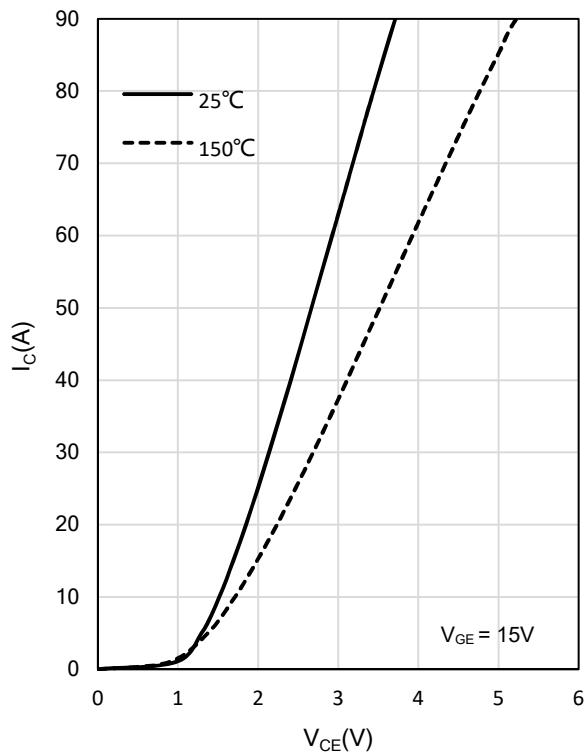


Fig. 3 Turn-off time vs. gate resistor

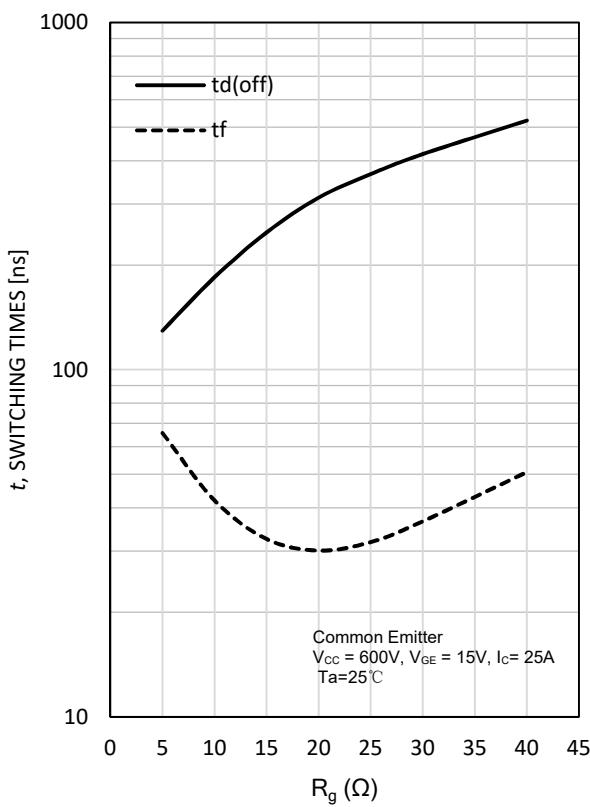


Fig. 4 Turn-off time vs. collector current

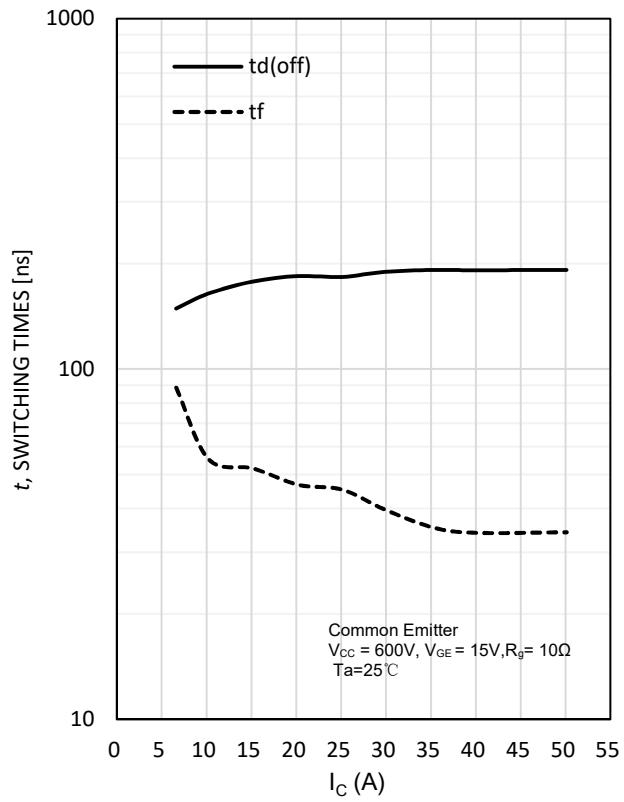


Fig. 5 Switching loss vs. gate resistor

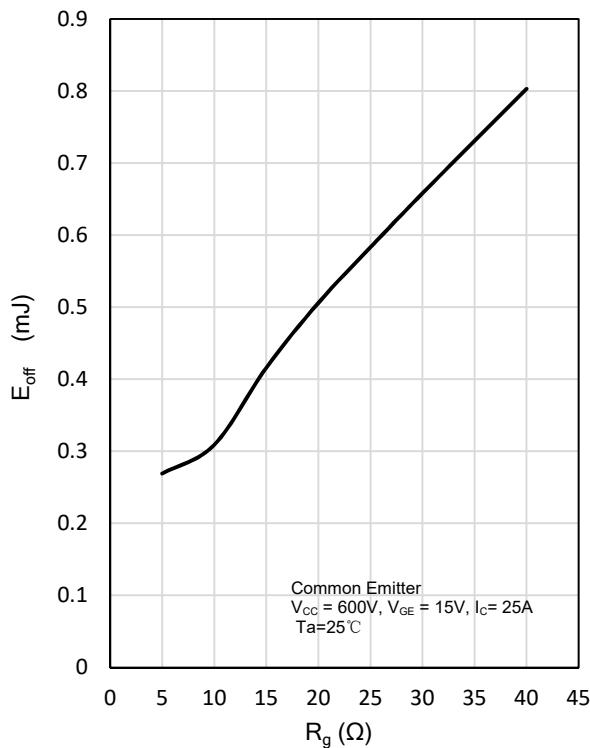


Fig. 6 Switching loss vs. collector current

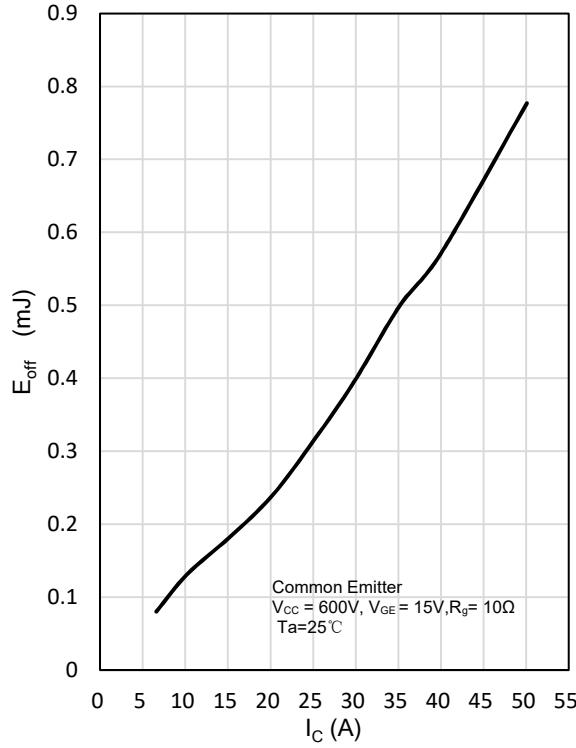


Fig. 7 Gate charge characteristics

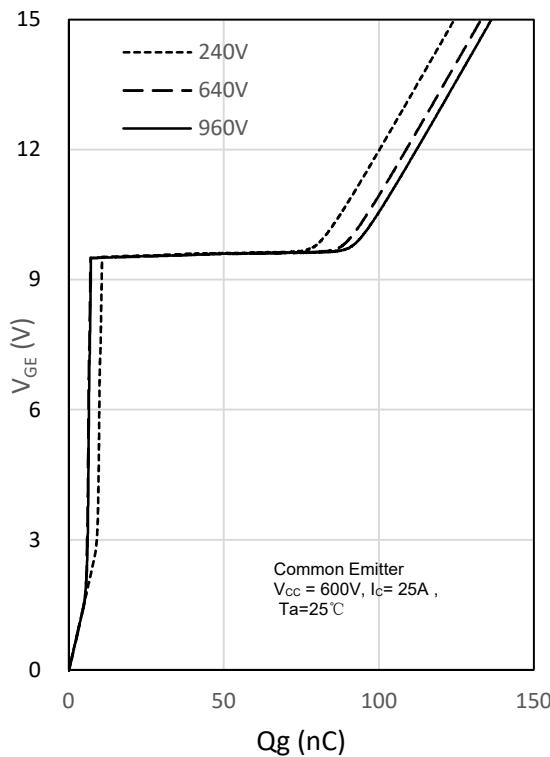
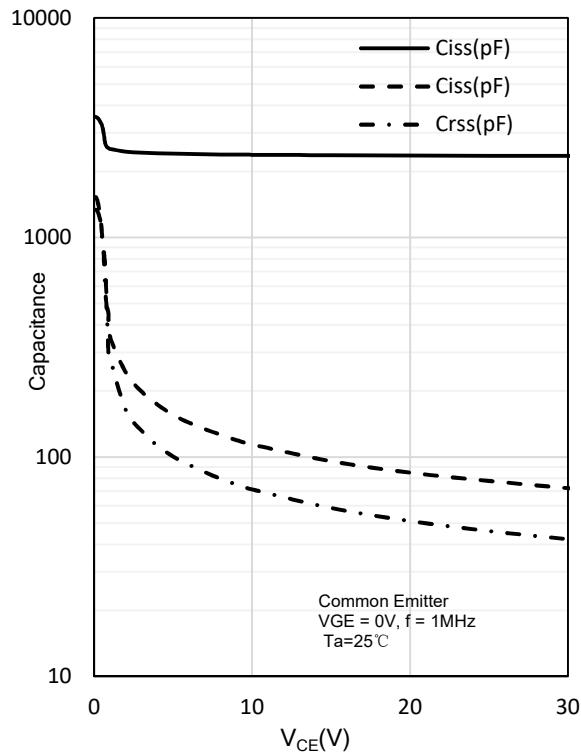
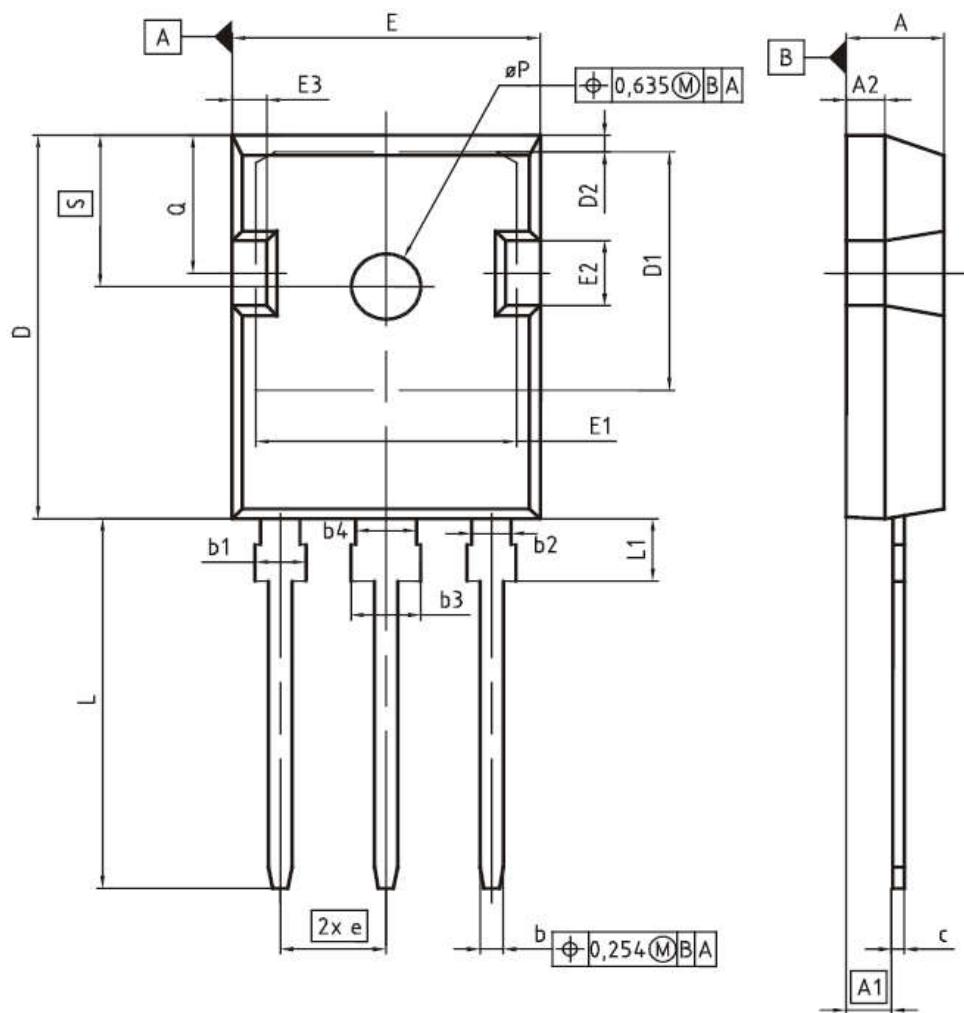


Fig. 8 Capacitance characteristics



**PG-T0247-3**


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
øP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248